

Peak 3A DDR Termination Regulator

FEATURES

- V_{CNTL} Input Voltage Range: 2.375V to 5.5V
- V_{IN} Input Voltage Range: 1.1V to 5.5V
- Continuous 2A Source and Sink Current
- · Peak Current Up to 3A
- Support DDR / DDRII / DDRIII / Low Power DDRIII / DDRIV Requirements
- Low Output Voltage Offset, ±20mV
- High Accuracy Output Voltage at Full-Load
- Adjustable V_{OUT} by External Resistor
- Stable with 22 μ F Ceramic Output Capacitor
- Low External Component Count
- · Built in Soft Start, UVLO and OCP Protection
- Thermal Shutdown Protection
- SOP-8 and SOP-8 Exposed Pad Packages
- RoHS Compliant and Green Package

APPLICATIONS

- · Desktop PCs, Notebooks and Workstations
- · Graphic Cards
- Set Top Boxes, Digital TVs, Printers
- DDR/II/III Termination Voltage Supply

DESCRIPTION

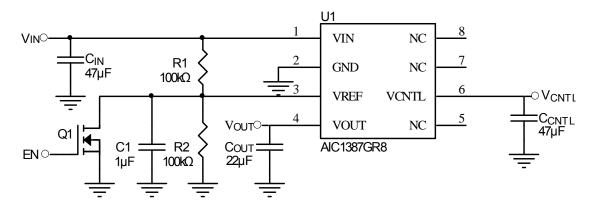
AIC1387 linear regulator is designed to deliver 2A continuous current while regulating an output voltage to within ±20mV and up to 3A peak transient currents for termination of DDR / DDRII / DDRIII. And it can deliver 1.5A continue current for termination of DDRIV.

AIC1387 converts voltage supplies range from 1.1V to 5.5V into an output voltage that adjusts by two external voltage divider resistors. It provides an excellent voltage source for active termination schemes of high-speed transmission lines as those seen in double data rate (DDR) memory system, and it meets the JEDEC SSTL-2 and SSTL-18 or other specific interfaces such as HSTL, SCSI-1 and SCSI-3 specifications for termination of DDR-SRAM.

Built-in current limiting in source and sink mode, on-chip thermal shutdown protection to against fault conditions.

The AIC1387 is available in the SOP-8 and SOP-8 with exposed pad package

TYPICAL APPLICATION CIRCUIT



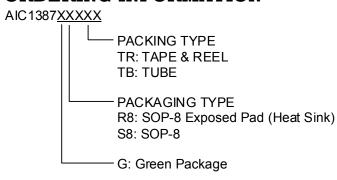
Typical Application Circuit

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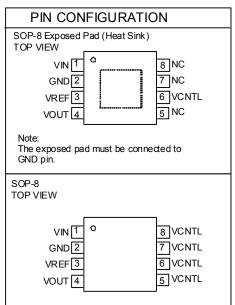


ORDERING INFORMATION



Example: AIC1387GR8TR

→ In Green SOP-8 Exposed Pad (Heat Sink)Package & Taping & Reel Packing



■ ABSOLUTE MAXIMUM RATINGS

V _{IN,} V _{REF} , V _{CNTL} , to GND	0.3V to 6V
Operating Temperature Range	-40°C ~ 85°C
Junction Temperature	150°C
Storage Temperature Range	65°C ~ 150°C
Lead Temperature (Soldering. 10 sec)	260°C
Thermal Resistance Junction to Ambient, θ_{JA}	SOP-8 Exposed Pad (Heat Sink)*60°C /W
	SOP-8160°C/W
Thermal Resistance Junction to Case, θ_{JC}	SOP-8 Exposed Pad (Heat Sink)*16°C /W
	SOP-840°C/W

(Assume no Ambient Airflow)

Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

*The package is place on a two layers PCB with 2 ounces copper and 2 square inch, connected by 8 vias.



■ ELECTRICAL CHARACTERISTICS

(V_{CNTL}=3.3V, V_{IN}=1.8V/1.5V, V_{REF}=0.5V_{IN}, C_{OUT}=22 μ F, T_A=25°C, unless otherwise specified) (Note 1)

PARAMETER	TEST CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Input Voltage	Keep operate V _{CNTL} ≥V _{IN} at power on and off sequences	V _{IN}	1.1	1.8	5.5	V	
		V _{CNTL}	2.375	3.3	5.5		
Output Voltage	I _{OUT} = 0mA	V _{OUT}		V_{REF}		V	
Output Voltage Offset	I _{OUT} = 0mA	Vos	-20		20	mV	
Load Regulation	I _{OUT} =0.1mA ~ +2A		-20		20	mV	
	I _{OUT} =0.1mA ~ -2A	ΔV_{LOR}	-20		20		
Quiescent Current	V _{REF} <0.2V, V _{OUT} = OFF	IQ		2	90	μА	
Operating Current of V _{CNTL}	No load	I _{CNTL}		1	2.5	mA	
Supply Current of V _{IN}	V _{CNTL} =5V, No load			1	3	mA	
V _{REF} Bias Current	V _{REF} =1.25V		0		1	μА	
Current Limit	Source: V _{OUT} =0.33xV _{REF} Sink: V _{OUT} =0.95x V _{IN}	I _{IL}	3.5	4.2		А	
Output Discharge Resistance	V _{REF} =0V, V _{OUT} =0.3V	R _{DSCHG}		18	25	Ω	
THERMAL PROTECTION							
Thermal Shutdown Temperature	3.3V≤V _{CNTL} ≤5V	T _{SD}		160		°C	
Thermal Shutdown Hysteresis	Guaranteed by design			30		°C	
SHUTDOWN SPECIFICATIONS							
Objected account The results and	Output ON (V _{REF} =0V→1.25V)		0.6				
Shutdown Threshold	Output OFF (V _{REF} =1.25V→0V)				0.2	V	

Note 1: Specifications are production tested at T_A =25°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).

Note 2: V_{OS} is the voltage measurement, which is defined as V_{OUT} subtracted V_{REF} .

Note 3: Load regulation is measured at constant junction temperature, using pulse testing with a low ON time.

Note 4: Current limit is measured by pulse load.

Note 5: For operate system safely; V_{CNTL} must be always greater than V_{IN} .



■ TYPICAL PERFORMANCE CHARACTERISTICS

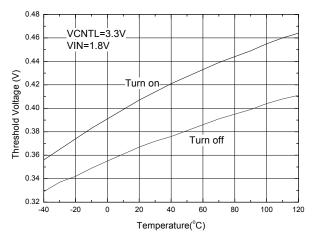


Fig.1 Turn on and turn off vs. Temperature

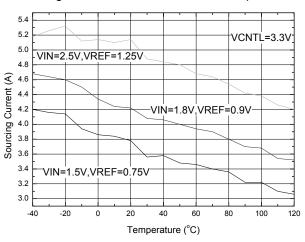


Fig.3 Current limit (Sourcing) vs. Temperature

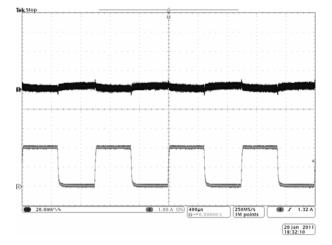


Fig.5 V_{IN} =1.5V, V_{REF} =0.75V Source Response

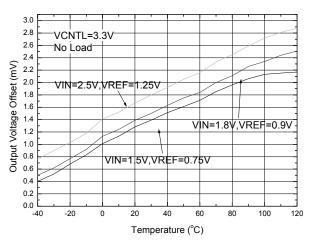


Fig.2 Output Voltage vs. Temperature

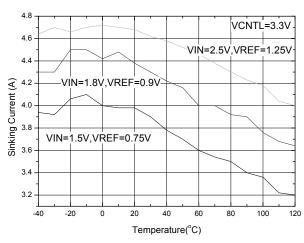


Fig.4 Current limit (Sinking) vs. Temperature

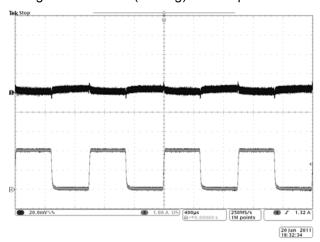


Fig.6 V_{IN} =1.8V, V_{REF}=0.9V Source Response



■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

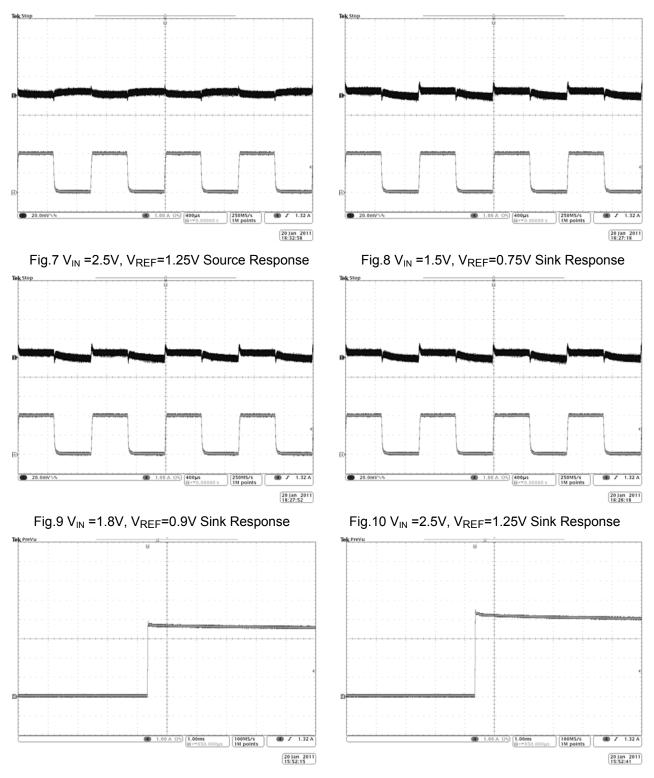


Fig.11 V_{IN} =1.5V, V_{REF} =0.75V Source Short Circuit Fig.12 V_{IN} =1.8V, V_{REF} =0.9V Source Short Circuit



■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

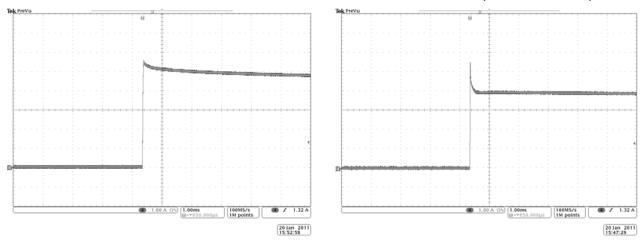


Fig.13 V_{IN} =2.5V, V_{REF} =1.25V Source Short Circuit Fig.14 V_{IN} =1.5V, V_{REF} =0.75V Sink Short Circuit

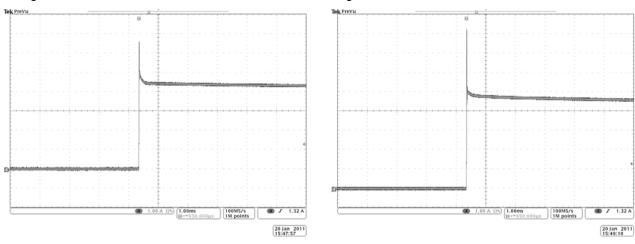
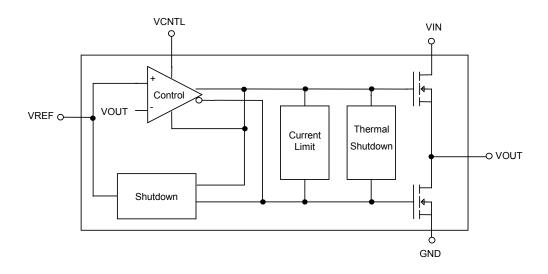


Fig.15 V_{IN} =1.8V, V_{REF} =0.9V Sink Short Circuit Fig.16 V_{IN} =2.5V, V_{REF} =1.25V Sink Short Circuit

BLOCK DIAGRAM





■ PIN DESCRIPTIONS

PIN 1: V_{IN} - Input supply pin. It provides

main power to create the external reference voltage by divider resistors for regulating

 V_{REF} and V_{OUT} .

PIN 2: GND - Ground pin.

PIN 3: V_{REF} - Reference voltage input. Pull

this pin low to shutdown device.

PIN 4: V_{OUT} -Output pin.

PIN 5: V_{CNTL} (SOP8)

NC(SOP8-EP)

PIN 6: V_{CNTL} - Input supply pin. It is used to

supply all the internal control circuitry.

PIN 7: V_{CNTL} (SOP8)

NC(SOP8-EP)

PIN 8: V_{CNTL} (SOP8)

NC(SOP8-EP)

APPLICATION INFORMATION

AlC1387 is a Continuous 2A source and sink current DDR termination regulator. It is specifically designed for low-cost and low-external component count system such as notebook PC applications. The AlC1387 possesses a high speed-operating amplifier that provides fast load transient response and only requires a $47\mu F$ ceramic input capacitor and $22\mu F$ ceramic output capacitor.

Layout Consideration

AlČ1387 is in SOP-8 with exposed pad package resulting in able to dissipate heat easily when it operates in high current. In order to prevent maximum junction temperature exceeded, the suitable copper area has to use.

The large copper at GND pins is available, and the heat dissipation is relieved. Using via to lead heat into the bottom layer. All capacitors should be placed as close as possible to relative pins.

Low VCTNL Applications

AIC1385 can be used in an application system where either a 2.5V, 3.3V or 5.0V rail is available. The VCTNL minimum input voltage requirement is 2.375V. If a 2.5V rail is used, the maximum continuous Source and Sink Current is 1.5A.

Thermal Considerations

For continuous operation, do not exceed absolute maximum operation junction temperature. The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surroundings airflow and temperature difference between junctions to ambient.

The maximum power dissipation can be calculated by following formula:

$$P_{D(max)} = [T_{J(max)} - T_A] / \theta_{JA}$$

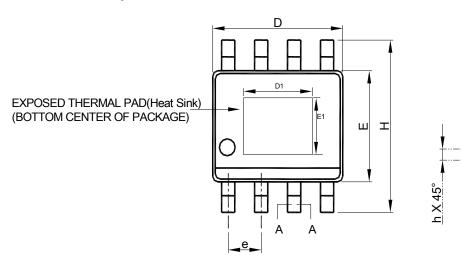
Where $T_{J(max)}$ is the maximum operation junction temperature, T_A is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance. For recommended operating conditions specification of the AIC1387, the maximum junction temperature is 150°C. The thermal resistance θ_{JA} for SOP-8 with exposed pad package is 60°C/W. The maximum power dissipation at T_A = 25°C can be calculated by following formula:

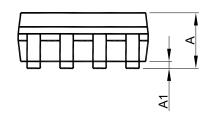
 $P_{D(max)}$ = [150°C -25°C] /60°C/W =2.08W for SOP-8 with exposed pad package.

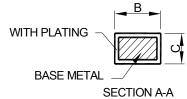


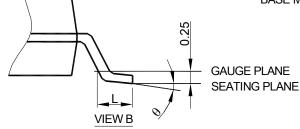
PHYSICAL DIMENSIONS (unit: mm)

SOP-8 Exposed Pad









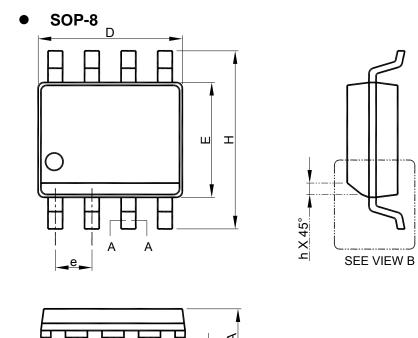
Note: 1. Refer to JEDEC MS-012
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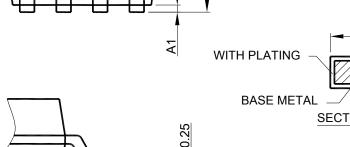
- 2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side .
- 3. Dimension "E" does not include inter-lead flash or protrusions.
- 4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

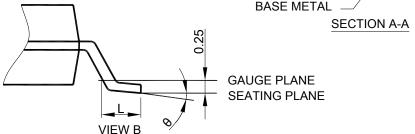
S	SOP-8 Exposed Pad(Heat Sink)			
S Y M B O	MILLIM	MILLIMETERS		
O L	MIN.	MAX.		
Α	1.35	1.75		
A1	0.00	0.15		
В	0.31	0.51		
С	0.17	0.25		
D	4.80	5.00		
D1	1.50	3.50		
Е	3.80	4.00		
E1	1.0	2.55		
е	1.27 BSC			
Н	5.80	6.20		
h	0.25	0.50		
L	0.40	1.27		
θ	0°	8°		

SEE VIEW B









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- 3. Dimension "E" does not include inter-lead flash or protrusions.
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S Y M	SOP-8		
M B	MILLIMETERS		
B O L	MIN.	MAX.	
Α	1.35	1.75	
A1	0.10	0.25	
В	0.33	0.51	
С	0.19	0.25	
D	4.80	5.00	
Е	3.80	4.00	
е	1.27 BSC		
Н	5.80	6.20	
h	0.25	0.50	
L	0.40	1.27	
θ	0°	8°	

Note:

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